

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT																				
NATURE OF CONVEYANCE:	ASSIGNMENT																				
CONVEYING PARTY DATA																					
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>JIN HWAN LEE</td> <td>01/13/2014</td> </tr> <tr> <td>KYOUNG SIK JO</td> <td>01/13/2014</td> </tr> <tr> <td>SANG WOOK LEE</td> <td>01/13/2014</td> </tr> <tr> <td>MIN YOUNG PARK</td> <td>01/13/2014</td> </tr> <tr> <td>SANG EON LEE</td> <td>01/13/2014</td> </tr> <tr> <td>KANG WON LEE</td> <td>01/13/2014</td> </tr> <tr> <td>JIN HA KIM</td> <td>01/13/2014</td> </tr> <tr> <td>HEON KWANG LIM</td> <td>01/13/2014</td> </tr> <tr> <td>SEUNG SEOB LEE</td> <td>01/13/2014</td> </tr> </tbody> </table>		Name	Execution Date	JIN HWAN LEE	01/13/2014	KYOUNG SIK JO	01/13/2014	SANG WOOK LEE	01/13/2014	MIN YOUNG PARK	01/13/2014	SANG EON LEE	01/13/2014	KANG WON LEE	01/13/2014	JIN HA KIM	01/13/2014	HEON KWANG LIM	01/13/2014	SEUNG SEOB LEE	01/13/2014
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SEUNG SEOB LEE	01/13/2014																				
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PROPERTY NUMBERS Total: 1																					
Property Type	Number																				
Application Number:	14233354																				
CORRESPONDENCE DATA																					

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Date:	01/16/2014

Total Attachments: 2
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U.S. ASSIGNMENT FOR PATENT AND PATENT APPLICATION

IN CONSIDERATION good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOR") by

CJ CHEILJEDANG CORPORATION
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&

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(hereinafter, "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

FOOD PACKING MATERIAL HAVING HYDROPHOBICITY, MANUFACTURING METHOD AND MOLD THEREOF

relating to International Patent Application PCT/KR2011/006432 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(a) executed on

(b) filed on

as Application No.

Any registered attorney of STEIN IP, LLC, 1400 Eye St., N.W., Suite 300, Washington, D.C. 20005 (202-216-9505), USPTO Customer Number 49,455, is hereby authorized to insert in (b) the specified data, when known.

and to said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon (collectively, hereinafter, "said application(s)"), and all Letters Patent of the United States granted on said application(s), for the full term or terms for which the said Letters Patent may be granted and including any extensions thereof (collectively, hereinafter, "said Letters Patent").

The ASSIGNOR agrees, when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

The ASSIGNOR covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Typed Name & Signature of Inventor(s))

(Date)

(Printed Name and Signature of Witness(es))

1) Jin Hwan LEE January 13, 2014
Jin Hwan LEE

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Kyoung Sik JO

3) Sang Wook LEE January 13, 2014
Sang Wook LEE

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5) Sang Eon LEE January 13, 2014
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6) Kang Won Lee January 13, 2014
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7) Jin Ha KIM January 13, 2014
Jin Ha KIM

8) Heon Kwang LIM January 13, 2014
Heon Kwang LIM

9) Seung Seob LEE January 13, 2014
Seung Seob LEE